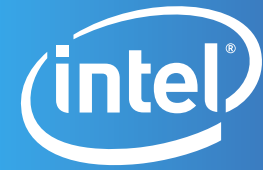


Intel® Next Unit of Computing Kit DCCP847DYE



only
4"x4"



PRODUCT BRIEF

The Shape that Fits the Future

TAKING BASIC COMPUTING TO A NEW LEVEL AND SIZE

The Intel® Next Unit of Computing (NUC) delivers new levels of performance and responsiveness in a pocket-sized solution. With an Intel Celeron® processor, the NUC is an affordable, customizable computing device that fits in the palm of your hand and offers a world of flexibility. With 8-channel audio and HDMI*, along with Microsoft* Windows 8, you can create a PC home theater system with touch capabilities that lets you experience your movies, photos, and music from the couch – or your office chair. Wireless capabilities let you access Hulu, iTunes, Netflix, Pandora, and other online content providers. Experience a difference you can truly see. Because the only thing more amazing than Intel® technology is what you'll do with it.



PRODUCT BRIEF

STUNNINGLY SMALL FORM FACTOR

The 4"×4"×2" form factor unlocks a world of potential design applications, from digital signage and kiosks to portable innovations.

ADVANCED TECHNOLOGY

The NUC features two SO-DIMM sockets for expandability up to 16 GB of memory, two PCIe* mini-card connectors for flexible support of wireless and SSD configurations, BIOS Vault Technology, Fast Boot and the Intel® Visual BIOS.

Integrated Board	<ul style="list-style-type: none">• DCP847SKE
Dimensions	<ul style="list-style-type: none">• 116.6mm×112.0mm×39.0mm (4.59"×4.41"×1.55")
Cooling	<ul style="list-style-type: none">• Active
Drive options	<ul style="list-style-type: none">• mSATA
Color options	<ul style="list-style-type: none">• Grey only
Chassis design	<ul style="list-style-type: none">• Aluminum and plastic
P/S	<ul style="list-style-type: none">• 19V, 65W DC-DC power adapter
Additional Features	<ul style="list-style-type: none">• Antenna for WIFI and Bluetooth pre-assembled for ease of deployment• Front Panel USB 2.0• VESA mounting bracket included• Integration Guide• 3 year product life cycle



Full PC functionality in its simplest form ...with Next Unit of Computing Board DCP847SKE

Intel® Gigabit Ethernet

Dual HDMI ports supporting dual independent display capability

Dual USB 2.0 Ports

19V, 65W DC Power connector

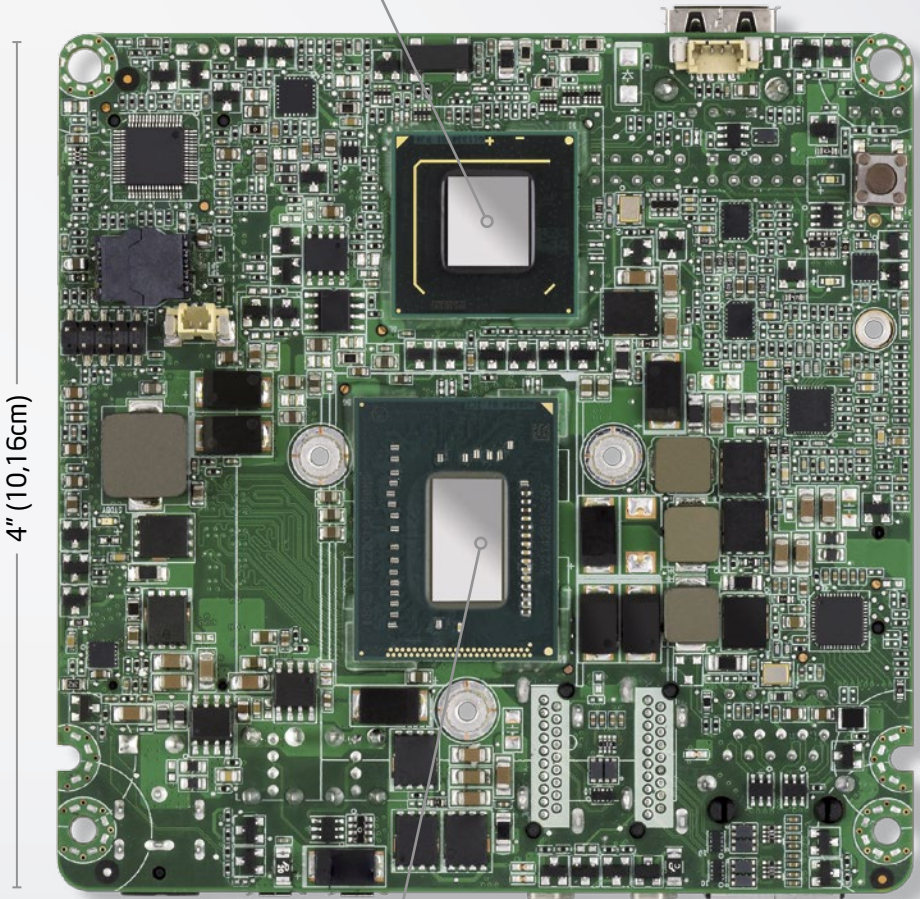


Dual Mini PCIe slots for expandability

Front Panel USB 2.0 Port

Dual SO-DIMM sockets for memory expandability up to 16GB

Intel® QS77 Express chipset



4" (10,16cm)

4" (10,16cm)

Intel® Celeron™ 847 (soldered down)



Intel® Next Unit of Computing Kit DCCP847DYE

Technical Specifications



PROCESSOR

Processor Support

- Intel® Celeron™ Processor 847 (1.10 GHz, 2M Cache)
- Supports Intel® 64 architecture³

CHIPSET

- Intel® QS77 Express Chipset

GRAPHICS

- Intel® HD Graphics
- Dual HDMI Ports supporting dual independent display capability

PERIPHERAL CONNECTIVITY

- Integrated Intel® 10/100/1000 Network Connection
- Three Hi-Speed USB 2.0 ports (two back panel ports and one front panel port)

EXPANSION CAPABILITIES²

- One full length mini-PCIe slot supporting mSATA capability
- One half length mini-PCIe slot with dual USB 2.0 ports routed

SYSTEM BIOS

- Intel® Visual Bios
 - 64 Mb Flash EEPROM with Intel® Platform Innovation Framework for EFI Plug and Play
 - Advanced configuration and power interface V3.0b, SMBIOS2.5
 - Intel® Express BIOS update support
- Fast Boot BIOS - Optimized POST for almost instant-on access to PC from power on**

SYSTEM MEMORY¹

Memory Capacity

- Dual-channel DDR3 with two connectors for 1066/1333 MHz memory support (16 GB max)

Memory Voltage

- 1.5V and 1.35 V

HARDWARE MANAGEMENT FEATURES

- Processor fan speed control
- Voltage and temperature sensing
- Fan sensor inputs used to monitor fan activity
- ACPI-compliant power management control

INTEL® PRO 10/100/1000 NETWORK CONNECTION

- Low-power design

AUDIO

- Intel® High Definition Audio (Intel® HD Audio) via two HDMI 1.4a outputs supporting 8 channel (7.1) digital audio

Indicators and Controls

- HDD LED, Power LED
- Power on/off

MECHANICAL

Chassis Size

- 4.59"×4.41"×1.55" (116.6mm×112.0mm×39.0mm)

Board Size

- 4"×4" (101.6mm×101.6mm)

Baseboard Power Requirements

- DC Power 19V, 65 Watt

ENVIRONMENT

Operating Temperature

- 0°C to +55°C

Storage Temperature

- -20°C to +70°C

COMPLIANCE WITH REGULATIONS AND STANDARDS

Safety Regulations

- UL/CSA 60950-1
- EN 60950-1
- IEC 60950-1
- NOM-019-SCFI-1998
- GOST-R

EMC Class B Regulations

- CISPR 22
- CISPR 24
- FCC 47 CFR Part 15, Subpart B
- ICES-003
- EN 55022
- EN 55024
- EN 61000-3-2
- EN 61000-3-3
- IEC/EN 61000-4 Series
- VCCI V-3
- KN-22
- KN-24
- CNS 13438

ENVIRONMENTAL COMPLIANCE

- Europe RoHS
- China RoHS

¹ WARNING: Altering PC memory frequency, voltage and/or latency may: (i) reduce system stability and useful life of the system, memory and processor; (ii) cause the processor and other system components to fail; (iii) cause reductions in system performance; (iv) cause additional heat or other damage; and (v) affect system data integrity. Intel has not tested, and does not warrant, the operation of the memory beyond its specifications. Intel assumes no responsibility that the memory, including if used with altered clock frequencies and/or voltages, will be fit for any particular purpose. Check with memory manufacturer for warranty and additional details.

² System resources and hardware (such as PCI and PCI Express*) require physical memory address locations that can reduce available addressable system memory. This could result in a reduction of as much as 1 GB or more of physical addressable memory being available to the operating system and applications, depending on the system configuration and operating system.

³ 64-bit computing on Intel® architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processors will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See <http://developer.intel.com/technology/intel64/index.htm> for more information.

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Actual Intel® Desktop Board may differ from the image shown.

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02/13/FH/MED/PDF 328671-001US

